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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	3584
Number of Logic Elements/Cells	-
Total RAM Bits	1769472
Number of I/O	720
Number of Gates	3000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v3000-5ffg1152i

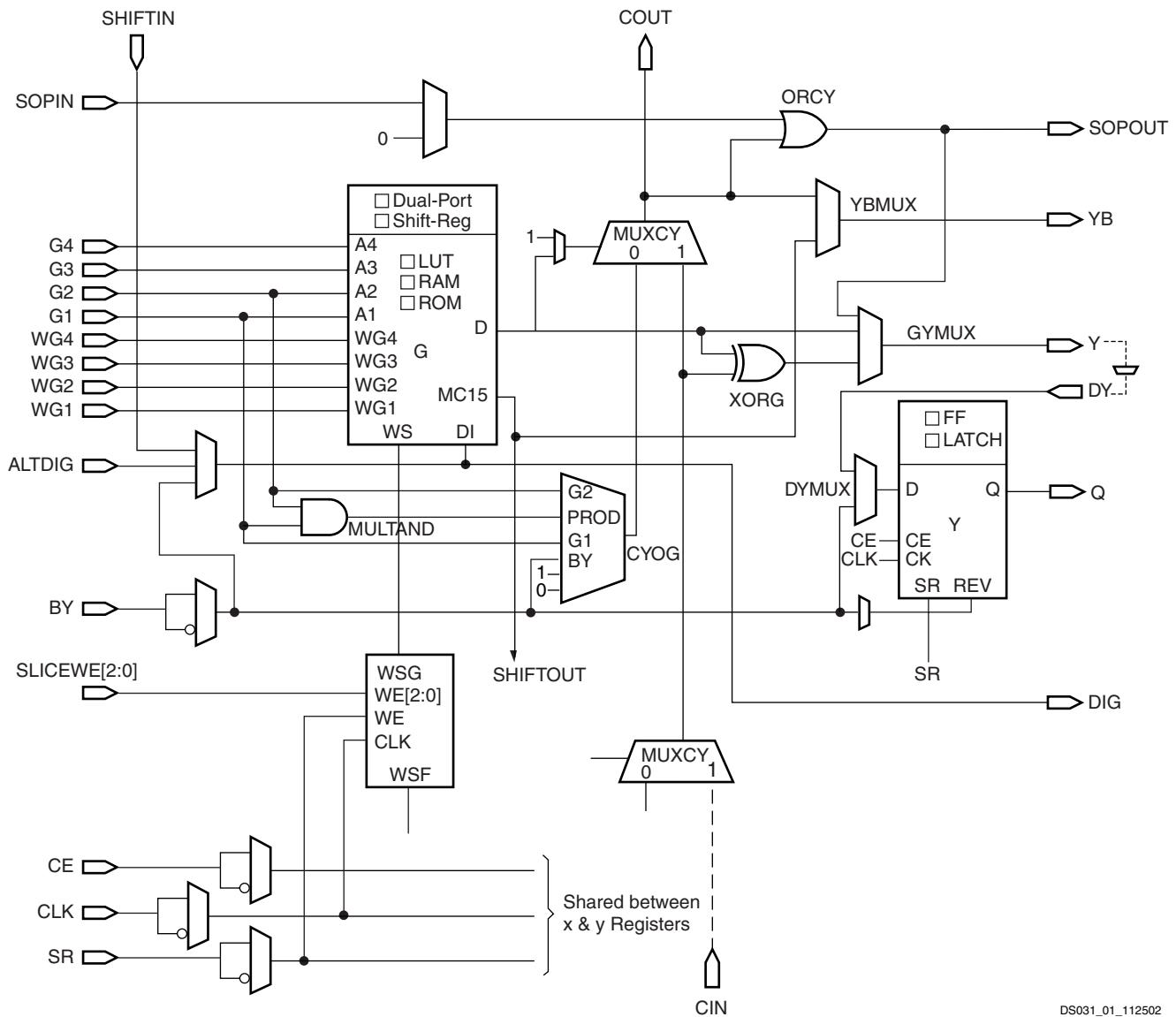


Figure 16: Virtex-II Slice (Top Half)

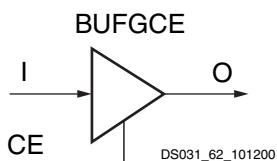


Figure 42: Virtex-II BUFGCE Function

If the CE input is inactive (Low) prior to the incoming rising clock edge, the following clock pulse does not pass through the clock buffer, and the output stays Low. Any level change of CE during the incoming clock High time has no effect. CE must not change during a short setup window just prior to the rising clock edge on the BUFGCE input I. Violating this setup time requirement can result in an undefined runt pulse output.

BUFGMUX

BUFGMUX can switch between two unrelated, even asynchronous clocks. Basically, a Low on S selects the I0 input, a High on S selects the I1 input. Switching from one clock to the other is done in such a way that the output High and Low time is never shorter than the shortest High or Low time of either input clock. As long as the presently selected clock is High, any level change of S has no effect.

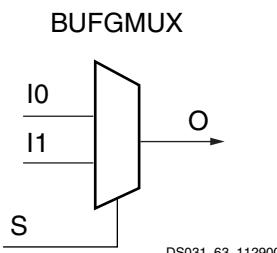


Figure 43: Virtex-II BUFGMUX Function

If the presently selected clock is Low while S changes, or if it goes Low after S has changed, the output is kept Low until the other ("to-be-selected") clock has made a transition from High to Low. At that instant, the new clock starts driving the output.

The two clock inputs can be asynchronous with regard to each other, and the S input can change at any time, except for a short setup time prior to the rising edge of the presently selected clock (I0 or I1). Violating this setup time requirement can result in an undefined runt pulse output.

All Virtex-II devices have 16 global clock multiplexer buffers.

Figure 44 shows a switchover from I0 to I1.

- The current clock is CLK0.
- S is activated High.
- If CLK0 is currently High, the multiplexer waits for CLK0 to go Low.
- Once CLK0 is Low, the multiplexer output stays Low

until CLK1 transitions High to Low.

- When CLK1 transitions from High to Low, the output switches to CLK1.
- No glitches or short pulses can appear on the output.

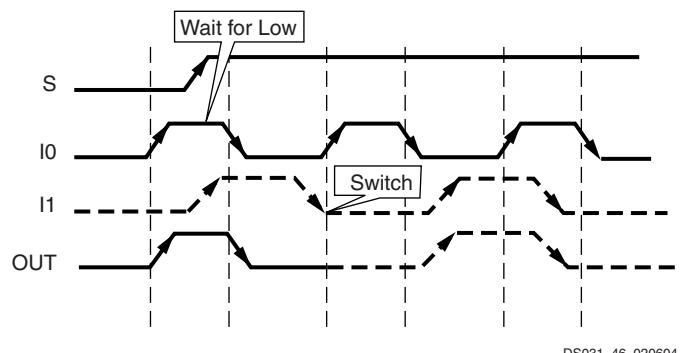


Figure 44: Clock Multiplexer Waveform Diagram

Local Clocking

In addition to global clocks, there are local clock resources in the Virtex-II devices. There are more than 72 local clocks in the Virtex-II family. These resources can be used for many different applications, including but not limited to memory interfaces. For example, even using only the left and right I/O banks, Virtex-II FPGAs can support up to 50 local clocks for DDR SDRAM. These interfaces can operate beyond 200 MHz on Virtex-II devices.

Digital Clock Manager (DCM)

The Virtex-II DCM offers a wide range of powerful clock management features.

- **Clock De-skew:** The DCM generates new system clocks (either internally or externally to the FPGA), which are phase-aligned to the input clock, thus eliminating clock distribution delays.
- **Frequency Synthesis:** The DCM generates a wide range of output clock frequencies, performing very flexible clock multiplication and division.
- **Phase Shifting:** The DCM provides both coarse phase shifting and fine-grained phase shifting with dynamic phase shift control.

The DCM utilizes fully digital delay lines allowing robust high-precision control of clock phase and frequency. It also utilizes fully digital feedback systems, operating dynamically to compensate for temperature and voltage variations during operation.

Up to four of the nine DCM clock outputs can drive inputs to global clock buffers or global clock multiplexer buffers simultaneously (see **Figure 45**). All DCM clock outputs can simultaneously drive general routing resources, including routes to output buffers.

Table 6: DC Input and Output Levels (Continued)

Input/Output Standard	V _{IL}		V _{IH}		V _{OL}		V _{OH}	I _{OL}	I _{OH}
	V, Min	V, Max	V, Min	V, Max	V, Max	V, Min	mA	mA	
SSTL3 I	-0.5	V _{REF} - 0.2	V _{REF} + 0.2	V _{CCO} + 0.5	V _{REF} - 0.6	V _{REF} + 0.6	8	-8	
SSTL3 II	-0.5	V _{REF} - 0.2	V _{REF} + 0.2	V _{CCO} + 0.5	V _{REF} - 0.8	V _{REF} + 0.8	16	-16	
SSTL2 I	-0.5	V _{REF} - 0.15	V _{REF} + 0.15	V _{CCO} + 0.5	V _{REF} - 0.65	V _{REF} + 0.65	7.6	-7.6	
SSTL2 II	-0.5	V _{REF} - 0.15	V _{REF} + 0.15	V _{CCO} + 0.5	V _{REF} - 0.80	V _{REF} + 0.80	15.2	-15.2	
AGP	-0.5	V _{REF} - 0.2	V _{REF} + 0.2	V _{CCO} + 0.5	10% V _{CCO}	90% V _{CCO}	Note 2	Note 2	

Notes:

1. V_{OL} and V_{OH} for lower drive currents are sample tested. The DONE pin is always LVTTL 12 mA.
2. Tested according to the relevant specifications.
3. LVTTL and LVCMOS inputs have approximately 100 mV of hysteresis.

LDT Differential Signal DC Specifications (LDT_25)

Table 7: LDT DC Specifications

DC Parameter	Symbol	Conditions	Min	Typ	Max	Units
Differential Output Voltage	V _{OD}	R _T = 100 Ω across Q and \bar{Q} signals	500	600	700	mV
Change in V _{OD} Magnitude	Δ V _{OD}		-15		15	mV
Output Common Mode Voltage	V _{OCM}	R _T = 100 Ω across Q and \bar{Q} signals	560	600	640	mV
Change in V _{OS} Magnitude	Δ V _{OCM}		-15		15	mV
Input Differential Voltage	V _{ID}		200	600	1000	mV
Change in V _{ID} Magnitude	Δ V _{ID}		-15		15	mV
Input Common Mode Voltage	V _{ICM}		500	600	700	mV
Change in V _{ICM} Magnitude	Δ V _{ICM}		-15		15	mV

LVDS DC Specifications (LVDS_33 & LVDS_25)

Table 8: LVDS DC Specifications

DC Parameter	Symbol	Conditions	Min	Typ	Max	Units
Supply Voltage	V _{CCO}		3.3 or 2.5			V
Output High Voltage for Q and \bar{Q}	V _{OH}	R _T = 100 Ω across Q and \bar{Q} signals			1.575	V
Output Low Voltage for Q and \bar{Q}	V _{OL}	R _T = 100 Ω across Q and \bar{Q} signals	0.925			V
Differential Output Voltage (Q - \bar{Q}), Q = High (\bar{Q} - Q), \bar{Q} = High	V _{ODIFF}	R _T = 100 Ω across Q and \bar{Q} signals	250	350	400	mV
Output Common-Mode Voltage	V _{OCM}	R _T = 100 Ω across Q and \bar{Q} signals	1.125	1.2	1.375	V
Differential Input Voltage (Q - \bar{Q}), Q = High (\bar{Q} - Q), \bar{Q} = High	V _{IDIFF}	Common-mode input voltage = 1.25 V	100	350	N/A	mV
Input Common-Mode Voltage	V _{ICM}	Differential input voltage = ±350 mV	0.2	1.25	V _{CCO} - 0.5	V

Virtex-II Performance Characteristics

This section provides the performance characteristics of some common functions and designs implemented in Virtex-II devices. The numbers reported here are worst-case values; they have all been fully characterized. Note that these values are subject to the same guidelines as [Virtex-II Switching Characteristics, page 9](#) (speed files).

Table 11: Pin-to-Pin Performance

Description	Device Used & Speed Grade	Pin-to-Pin (with I/O delays)	Units
Basic Functions			
16-bit Address Decoder	XC2V1000 -5	6.3	ns
32-bit Address Decoder	XC2V1000 -5	7.7	ns
64-bit Address Decoder	XC2V1000 -5	9.3	ns
4:1 MUX	XC2V1000 -5	5.7	ns
8:1 MUX	XC2V1000 -5	6.5	ns
16:1 MUX	XC2V1000 -5	6.7	ns
32:1 MUX	XC2V1000 -5	8.7	ns
Combinatorial (pad to LUT to pad)	XC2V1000 -5	5.0	ns
Memory			
Block RAM			
Pad to setup		1.6	ns
Clock to Pad		9.5	ns
Distributed RAM			
Pad to setup	XC2V1000 -5	2.7	ns
Clock to Pad	XC2V1000 -5	5.1 (no clk skew)	ns

Table 12 shows internal (register-to-register) performance. Values are reported in MHz.

Table 12: Register-to-Register Performance

Description	Device Used & Speed Grade	Register-to-Register Performance	Units
Basic Functions			
16-bit Address Decoder	XC2V1000 -5	398	MHz
32-bit Address Decoder	XC2V1000 -5	291	MHz
64-bit Address Decoder	XC2V1000 -5	274	MHz
4:1 MUX	XC2V1000 -5	563	MHz
8:1 MUX	XC2V1000 -5	454	MHz
16:1 MUX	XC2V1000 -5	414	MHz
32:1 MUX	XC2V1000 -5	323	MHz
Register to LUT to Register	XC2V1000 -5	613	MHz

Multiplier Switching Characteristics

Table 24: Multiplier Switching Characteristics

Description	Symbol	Speed Grade			Units
		-6	-5	-4	
Propagation Delay to Output Pin					
Input to Pin 35	T _{MULT_P35}	4.66	8.50	10.36	ns, Max
Input to Pin 34	T _{MULT_P34}	4.57	8.33	10.15	ns, Max
Input to Pin 33	T _{MULT_P33}	4.47	8.16	9.95	ns, Max
Input to Pin 32	T _{MULT_P32}	4.37	7.99	9.74	ns, Max
Input to Pin 31	T _{MULT_P31}	4.28	7.82	9.53	ns, Max
Input to Pin 30	T _{MULT_P30}	4.18	7.65	9.33	ns, Max
Input to Pin 29	T _{MULT_P29}	4.08	7.48	9.12	ns, Max
Input to Pin 28	T _{MULT_P28}	3.99	7.31	8.91	ns, Max
Input to Pin 27	T _{MULT_P27}	3.89	7.14	8.70	ns, Max
Input to Pin 26	T _{MULT_P26}	3.79	6.97	8.50	ns, Max
Input to Pin 25	T _{MULT_P25}	3.69	6.80	8.29	ns, Max
Input to Pin 24	T _{MULT_P24}	3.60	6.63	8.08	ns, Max
Input to Pin 23	T _{MULT_P23}	3.50	6.46	7.88	ns, Max
Input to Pin 22	T _{MULT_P22}	3.40	6.29	7.67	ns, Max
Input to Pin 21	T _{MULT_P21}	3.31	6.12	7.46	ns, Max
Input to Pin 20	T _{MULT_P20}	3.21	5.95	7.26	ns, Max
Input to Pin 19	T _{MULT_P19}	3.11	5.78	7.05	ns, Max
Input to Pin 18	T _{MULT_P18}	3.02	5.61	6.84	ns, Max
Input to Pin 17	T _{MULT_P17}	2.92	5.44	6.63	ns, Max
Input to Pin 16	T _{MULT_P16}	2.82	5.27	6.43	ns, Max
Input to Pin 15	T _{MULT_P15}	2.72	5.10	6.22	ns, Max
Input to Pin 14	T _{MULT_P14}	2.63	4.93	6.01	ns, Max
Input to Pin 13	T _{MULT_P13}	2.53	4.76	5.81	ns, Max
Input to Pin 12	T _{MULT_P12}	2.43	4.59	5.60	ns, Max
Input to Pin 11	T _{MULT_P11}	2.34	4.42	5.39	ns, Max
Input to Pin 10	T _{MULT_P10}	2.24	4.25	5.19	ns, Max
Input to Pin 9	T _{MULT_P9}	2.14	4.08	4.98	ns, Max
Input to Pin 8	T _{MULT_P8}	2.05	3.91	4.77	ns, Max
Input to Pin 7	T _{MULT_P7}	1.95	3.74	4.56	ns, Max
Input to Pin 6	T _{MULT_P6}	1.85	3.57	4.36	ns, Max
Input to Pin 5	T _{MULT_P5}	1.75	3.40	4.15	ns, Max
Input to Pin 4	T _{MULT_P4}	1.66	3.23	3.94	ns, Max
Input to Pin 3	T _{MULT_P3}	1.56	3.06	3.74	ns, Max
Input to Pin 2	T _{MULT_P2}	1.46	2.89	3.53	ns, Max
Input to Pin 1	T _{MULT_P1}	1.37	2.72	3.32	ns, Max
Input to Pin 0	T _{MULT_P0}	1.27	2.55	3.12	ns, Max

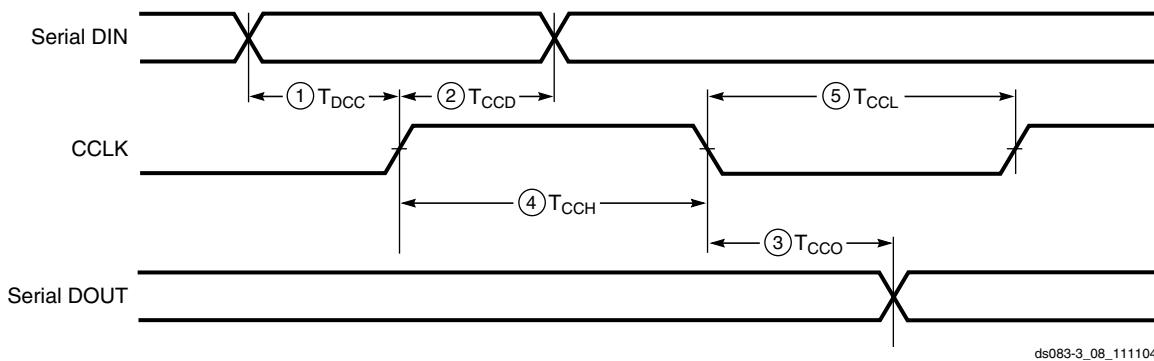


Figure 3: Slave Serial Mode Timing Sequence

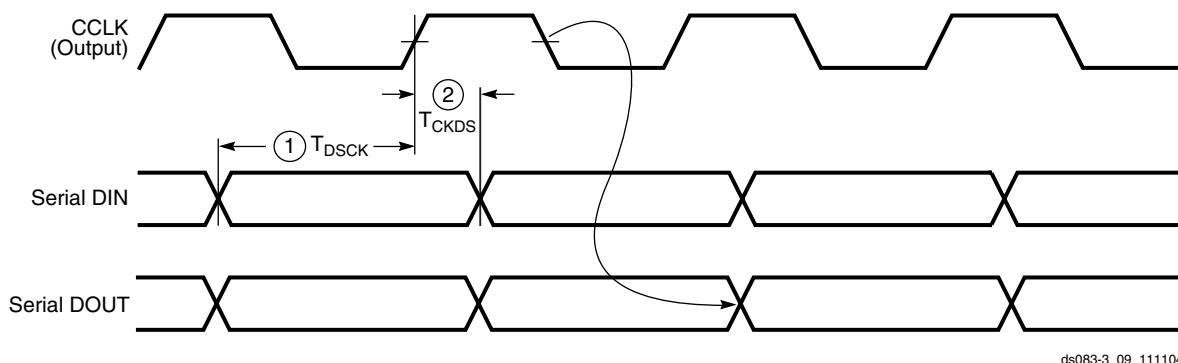


Figure 4: Master Serial Mode Timing Sequence

Table 31: Master/Slave Serial Mode Timing Characteristics

	Description	Figure References	Symbol	Value	Units
CCLK	DIN setup/hold, slave mode (Figure 3)	1/2	T _{DCC} /T _{CCD}	5.0/0.0	ns, min
	DIN setup/hold, master mode (Figure 4)	1/2	T _{DSCK} /T _{CKDS}	5.0/0.0	ns, min
	DOUT	3	T _{CCO}	12.0	ns, max
	High time	4	T _{CCH}	5.0	ns, min
	Low time	5	T _{CCL}	5.0	ns, min
	Maximum start-up frequency		F _{CC_STARTUP}	50	MHz, max
	Maximum frequency		F _{CC_SERIAL}	66 ⁽¹⁾	MHz, max
	Frequency tolerance, master mode with respect to nominal			+45% -30%	

Notes:

1. If no provision is made in the design to adjust the frequency of CCLK, F_{CC_SERIAL} should not exceed F_{CC_STARTUP}.

Master/Slave SelectMAP Parameters

Figure 5 is a generic timing diagram for data loading using SelectMAP. For other data loading diagrams, refer to the [Virtex-II Pro Platform FPGA User Guide](#).

Input Clock Tolerances

Table 39: Input Clock Tolerances

Description	Symbol	F_{CLKIN}	Speed Grade						Units	
			-6		-5		-4			
			Min	Max	Min	Max	Min	Max		
Input Clock Low/High Pulse Width										
PSCLK	PSCLK_PULSE	< 1MHz	25.00		25.00		25.00		ns	
PSCLK and CLKIN ⁽³⁾	PSCLK_PULSE and CLKIN_PULSE	1 – 10 MHz	25.00		25.00		25.00		ns	
		10 – 25 MHz	10.00		10.00		10.00		ns	
		25 – 50 MHz	5.00		5.00		5.00		ns	
		50 – 100 MHz	3.00		3.00		3.00		ns	
		100 – 150 MHz	2.40		2.40		2.40		ns	
		150 – 200 MHz	2.00		2.00		2.00		ns	
		200 – 250 MHz	1.80		1.80		1.80		ns	
		250 – 300 MHz	1.50		1.50		1.50		ns	
		300 – 350 MHz	1.30		1.30		1.30		ns	
		350 – 400 MHz	1.15		1.15		1.15		ns	
		> 400 MHz	1.05		1.05		1.05		ns	
Input Clock Cycle-Cycle Jitter (Low Frequency Mode)										
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_CYC_JITT_DLL_LF			± 300		± 300		± 300	ps	
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_CYC_JITT_FX_LF			± 300		± 300		± 300	ps	
Input Clock Cycle-Cycle Jitter (High Frequency Mode)										
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_CYC_JITT_DLL_HF			± 150		± 150		± 150	ps	
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_CYC_JITT_FX_HF			± 150		± 150		± 150	ps	
Input Clock Period Jitter (Low Frequency Mode)										
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_PER_JITT_DLL_LF			± 1		± 1		± 1	ns	
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_PER_JITT_FX_LF			± 1		± 1		± 1	ns	
Input Clock Period Jitter (High Frequency Mode)										
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_PER_JITT_DLL_HF			± 1		± 1		± 1	ns	
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_PER_JITT_FX_HF			± 1		± 1		± 1	ns	
Feedback Clock Path Delay Variation										
CLKFB off-chip feedback	CLKFB_DELAY_VAR_EXT			± 1		± 1		± 1	ns	

Notes:

- “DLL outputs” is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
- If both DLL and CLKFX outputs are used, follow the more restrictive specification.
- If DCM phase shift feature is used and CLKIN frequency > 200 Mhz, CLKIN duty cycle must be within $\pm 5\%$ (45/55 to 55/45).

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
4	IO_L02N_4/D0/DIN ⁽¹⁾	V18		
4	IO_L02P_4/D1	V17		
4	IO_L03N_4/D2/ALT_VRP_4	W18		
4	IO_L03P_4/D3/ALT_VRN_4	Y18		
4	IO_L04N_4/VREF_4	AA18		
4	IO_L04P_4	AB18		
4	IO_L05N_4/VRP_4	W17		
4	IO_L05P_4/VRN_4	Y17		
4	IO_L06N_4	AA17		
4	IO_L06P_4	AB17		
4	IO_L19N_4	V16	NC	NC
4	IO_L19P_4	V15	NC	NC
4	IO_L21N_4	W16	NC	NC
4	IO_L21P_4/VREF_4	Y16	NC	NC
4	IO_L22N_4	AA16	NC	NC
4	IO_L22P_4	AB16	NC	NC
4	IO_L24N_4	W15	NC	NC
4	IO_L24P_4	Y15	NC	NC
4	IO_L49N_4	AA15	NC	
4	IO_L49P_4	AB15	NC	
4	IO_L51N_4	U14	NC	
4	IO_L51P_4/VREF_4	V14	NC	
4	IO_L52N_4	W14	NC	
4	IO_L52P_4	Y14	NC	
4	IO_L54N_4	AA14	NC	
4	IO_L54P_4	AB14	NC	
4	IO_L91N_4/VREF_4	U13		
4	IO_L91P_4	V13		
4	IO_L92N_4	W13		
4	IO_L92P_4	Y13		
4	IO_L93N_4	AA13		
4	IO_L93P_4	AB13		
4	IO_L94N_4/VREF_4	U12		
4	IO_L94P_4	V12		

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
0	VCCO_0	F7		
1	VCCO_1	G14		
1	VCCO_1	G13		
1	VCCO_1	G12		
1	VCCO_1	F16		
1	VCCO_1	F15		
2	VCCO_2	L16		
2	VCCO_2	K16		
2	VCCO_2	J16		
2	VCCO_2	H17		
2	VCCO_2	G17		
3	VCCO_3	T17		
3	VCCO_3	R17		
3	VCCO_3	P16		
3	VCCO_3	N16		
3	VCCO_3	M16		
4	VCCO_4	U16		
4	VCCO_4	U15		
4	VCCO_4	T14		
4	VCCO_4	T13		
4	VCCO_4	T12		
5	VCCO_5	U8		
5	VCCO_5	U7		
5	VCCO_5	T11		
5	VCCO_5	T10		
5	VCCO_5	T9		
6	VCCO_6	T6		
6	VCCO_6	R6		
6	VCCO_6	P7		
6	VCCO_6	N7		
6	VCCO_6	M7		
7	VCCO_7	L7		
7	VCCO_7	K7		
7	VCCO_7	J7		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
NA	GND	R12		
NA	GND	R11		
NA	GND	R10		
NA	GND	P25		
NA	GND	P17		
NA	GND	P16		
NA	GND	P15		
NA	GND	P14		
NA	GND	P13		
NA	GND	P12		
NA	GND	P11		
NA	GND	P10		
NA	GND	P2		
NA	GND	N25		
NA	GND	N17		
NA	GND	N16		
NA	GND	N15		
NA	GND	N14		
NA	GND	N13		
NA	GND	N12		
NA	GND	N11		
NA	GND	N10		
NA	GND	N2		
NA	GND	M17		
NA	GND	M16		
NA	GND	M15		
NA	GND	M14		
NA	GND	M13		
NA	GND	M12		
NA	GND	M11		
NA	GND	M10		
NA	GND	L17		
NA	GND	L16		
NA	GND	L15		
NA	GND	L14		
NA	GND	L13		
NA	GND	L12		

BG575/BGG575 Standard BGA Package

As shown in [Table 9](#), XC2V1000, XC2V1500, and XC2V2000 Virtex-II devices are available in the BG575/BGG575 BGA package. Pins in the XC2V1000, XC2V1500, and XC2V2000 devices are the same, except for the pin differences in the XC2V1000 and XC2V1500 devices shown in the No Connect columns. Following this table are the [BG575/BGG575 Standard BGA Package Specifications \(1.27mm pitch\)](#).

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
0	IO_L01N_0	A3		
0	IO_L01P_0	A4		
0	IO_L02N_0	D5		
0	IO_L02P_0	C5		
0	IO_L03N_0/VRP_0	E6		
0	IO_L03P_0/VRN_0	D6		
0	IO_L04N_0/VREF_0	F7		
0	IO_L04P_0	E7		
0	IO_L05N_0	G8		
0	IO_L05P_0	H9		
0	IO_L06N_0	A5		
0	IO_L06P_0	A6		
0	IO_L19N_0	B5		
0	IO_L19P_0	B6		
0	IO_L21N_0	D7		
0	IO_L21P_0/VREF_0	C7		
0	IO_L22N_0	F8		
0	IO_L22P_0	E8		
0	IO_L24N_0	G9		
0	IO_L24P_0	F9		
0	IO_L49N_0	G10		
0	IO_L49P_0	H10		
0	IO_L51N_0	B7		
0	IO_L51P_0/VREF_0	B8		
0	IO_L52N_0	D8		
0	IO_L52P_0	C8		
0	IO_L54N_0	E9		
0	IO_L54P_0	D9		
0	IO_L67N_0	A8	NC	
0	IO_L67P_0	A9	NC	
0	IO_L69N_0	C9	NC	

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
4	IO_L91P_4	AB14		
4	IO_L92N_4	V14		
4	IO_L92P_4	Y14		
4	IO_L93N_4	AB13		
4	IO_L93P_4	AC13		
4	IO_L94N_4/VREF_4	Y13		
4	IO_L94P_4	AA13		
4	IO_L95N_4/GCLK3S	V13		
4	IO_L95P_4/GCLK2P	W13		
4	IO_L96N_4/GCLK1S	U14		
4	IO_L96P_4/GCLK0P	U13		
5	IO_L96N_5/GCLK7S	AD12		
5	IO_L96P_5/GCLK6P	AD11		
5	IO_L95N_5/GCLK5S	AC12		
5	IO_L95P_5/GCLK4P	AB12		
5	IO_L94N_5	AA12		
5	IO_L94P_5/VREF_5	Y12		
5	IO_L93N_5	W12		
5	IO_L93P_5	V12		
5	IO_L92N_5	U12		
5	IO_L92P_5	U11		
5	IO_L91N_5	AB11		
5	IO_L91P_5/VREF_5	AA11		
5	IO_L73N_5	Y11	NC	NC
5	IO_L73P_5	V11	NC	NC
5	IO_L72N_5	AD10	NC	
5	IO_L72P_5	AD9	NC	
5	IO_L70N_5	AC10	NC	
5	IO_L70P_5	AB10	NC	
5	IO_L69N_5/VREF_5	Y10	NC	
5	IO_L69P_5	W10	NC	
5	IO_L67N_5	V10	NC	
5	IO_L67P_5	U10	NC	
5	IO_L54N_5	AC9		
5	IO_L54P_5	AB9		

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
7	VCCO_7	F3		
NA	CCLK	AB23		
NA	PROG_B	C1		
NA	DONE	AB21		
NA	M0	AC4		
NA	M1	AB4		
NA	M2	AD3		
NA	HSWAP_EN	C2		
NA	TCK	C23		
NA	TDI	D1		
NA	TDO	C24		
NA	TMS	C21		
NA	PWRDWN_B	AC21		
NA	DXN	B4		
NA	DXP	C4		
NA	VBATT	B21		
NA	RSVD	A22		
NA	VCCAUX	AD13		
NA	VCCAUX	AC22		
NA	VCCAUX	AC3		
NA	VCCAUX	N1		
NA	VCCAUX	M24		
NA	VCCAUX	B22		
NA	VCCAUX	B3		
NA	VCCAUX	A12		
NA	VCCINT	U17		
NA	VCCINT	U8		
NA	VCCINT	T16		
NA	VCCINT	T9		
NA	VCCINT	R15		
NA	VCCINT	R14		
NA	VCCINT	R13		
NA	VCCINT	R12		
NA	VCCINT	R11		

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
NA	VCCINT	R10		
NA	VCCINT	P15		
NA	VCCINT	P10		
NA	VCCINT	N15		
NA	VCCINT	N10		
NA	VCCINT	M15		
NA	VCCINT	M10		
NA	VCCINT	L15		
NA	VCCINT	L10		
NA	VCCINT	K15		
NA	VCCINT	K14		
NA	VCCINT	K13		
NA	VCCINT	K12		
NA	VCCINT	K11		
NA	VCCINT	K10		
NA	VCCINT	J16		
NA	VCCINT	J9		
NA	VCCINT	H17		
NA	VCCINT	H8		
NA	GND	AD24		
NA	GND	AD23		
NA	GND	AD18		
NA	GND	AD7		
NA	GND	AD2		
NA	GND	AD1		
NA	GND	AC24		
NA	GND	AC23		
NA	GND	AC2		
NA	GND	AC1		
NA	GND	AB22		
NA	GND	AB3		
NA	GND	AA21		
NA	GND	AA15		
NA	GND	AA10		
NA	GND	AA4		
NA	GND	Y20		

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
NA	GND	D15		
NA	GND	D10		
NA	GND	D4		
NA	GND	C22		
NA	GND	C3		
NA	GND	B24		
NA	GND	B23		
NA	GND	B2		
NA	GND	B1		
NA	GND	A24		
NA	GND	A23		
NA	GND	A18		
NA	GND	A7		
NA	GND	A2		

Notes:

1. See [Table 4](#) for an explanation of the signals available on this pin.

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
1	IO_L27N_1/VREF_1	F19
1	IO_L27P_1	G19
1	IO_L25N_1	J19
1	IO_L25P_1	J20
1	IO_L24N_1	C20
1	IO_L24P_1	C21
1	IO_L22N_1	D20
1	IO_L22P_1	E21
1	IO_L21N_1/VREF_1	E20
1	IO_L21P_1	F20
1	IO_L19N_1	A21
1	IO_L19P_1	B21
1	IO_L06N_1	A22
1	IO_L06P_1	B22
1	IO_L05N_1	C22
1	IO_L05P_1	C23
1	IO_L04N_1	D22
1	IO_L04P_1/VREF_1	E22
1	IO_L03N_1/VRP_1	A23
1	IO_L03P_1/VRN_1	B23
1	IO_L02N_1	A24
1	IO_L02P_1	B24
1	IO_L01N_1	A25
1	IO_L01P_1	B25
2	IO_L01N_2	C27
2	IO_L01P_2	D27
2	IO_L02N_2/VRP_2	D25
2	IO_L02P_2/VRN_2	D26
2	IO_L03N_2	E24
2	IO_L03P_2/VREF_2	E25
2	IO_L04N_2	E26
2	IO_L04P_2	E27
2	IO_L06N_2	F23
2	IO_L06P_2	F24
2	IO_L19N_2	F25

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
2	VCCO_2	L10		
2	VCCO_2	L9		
2	VCCO_2	K9		
2	VCCO_2	E2		
3	VCCO_3	AF2		
3	VCCO_3	AA9		
3	VCCO_3	Y10		
3	VCCO_3	Y9		
3	VCCO_3	W10		
3	VCCO_3	W9		
3	VCCO_3	V10		
3	VCCO_3	V9		
3	VCCO_3	V3		
3	VCCO_3	U10		
3	VCCO_3	T10		
4	VCCO_4	AJ5		
4	VCCO_4	AH13		
4	VCCO_4	AB13		
4	VCCO_4	AB12		
4	VCCO_4	AB11		
4	VCCO_4	AB10		
4	VCCO_4	AA15		
4	VCCO_4	AA14		
4	VCCO_4	AA13		
4	VCCO_4	AA12		
4	VCCO_4	AA11		
5	VCCO_5	AJ26		
5	VCCO_5	AH18		
5	VCCO_5	AB21		
5	VCCO_5	AB20		
5	VCCO_5	AB19		
5	VCCO_5	AB18		
5	VCCO_5	AA20		
5	VCCO_5	AA19		
5	VCCO_5	AA18		
5	VCCO_5	AA17		
5	VCCO_5	AA16		

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
5	IO_L79P_5	AP21	NC
5	IO_L78N_5	AK22	
5	IO_L78P_5	AK21	
5	IO_L77N_5	AD18	
5	IO_L77P_5	AD19	
5	IO_L76N_5	AN22	
5	IO_L76P_5	AN21	
5	IO_L75N_5/VREF_5	AJ20	
5	IO_L75P_5	AH20	
5	IO_L74N_5	AG19	
5	IO_L74P_5	AG20	
5	IO_L73N_5	AP24	
5	IO_L73P_5	AP23	
5	IO_L72N_5	AL23	
5	IO_L72P_5	AL22	
5	IO_L71N_5	AF20	
5	IO_L71P_5	AF21	
5	IO_L70N_5	AM24	
5	IO_L70P_5	AM23	
5	IO_L69N_5/VREF_5	AJ21	
5	IO_L69P_5	AJ22	
5	IO_L68N_5	AJ24	
5	IO_L68P_5	AJ23	
5	IO_L67N_5	AN24	
5	IO_L67P_5	AN23	
5	IO_L60N_5	AN26	NC
5	IO_L60P_5	AN25	NC
5	IO_L54N_5	AL25	
5	IO_L54P_5	AL24	
5	IO_L53N_5	AE20	
5	IO_L53P_5	AE21	
5	IO_L52N_5	AN27	
5	IO_L52P_5	AP26	
5	IO_L51N_5/VREF_5	AP29	
5	IO_L51P_5	AP28	
5	IO_L50N_5	AG21	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
2	IO_L09P_2/VREF_2	H7	NC	
2	IO_L10N_2	G3	NC	
2	IO_L10P_2	F3	NC	
2	IO_L11N_2	J8	NC	
2	IO_L11P_2	K8	NC	
2	IO_L12N_2	H5	NC	
2	IO_L12P_2	G5	NC	
2	IO_L19N_2	G1		
2	IO_L19P_2	F1		
2	IO_L20N_2	K9		
2	IO_L20P_2	L10		
2	IO_L21N_2	K7		
2	IO_L21P_2/VREF_2	J7		
2	IO_L22N_2	H2		
2	IO_L22P_2	G2		
2	IO_L23N_2	L9		
2	IO_L23P_2	M9		
2	IO_L24N_2	H4		
2	IO_L24P_2	G4		
2	IO_L25N_2	J3		
2	IO_L25P_2	H3		
2	IO_L26N_2	M10		
2	IO_L26P_2	N10		
2	IO_L27N_2	K6		
2	IO_L27P_2/VREF_2	J6		
2	IO_L28N_2	K5		
2	IO_L28P_2	J5		
2	IO_L29N_2	N11		
2	IO_L29P_2	P11		
2	IO_L30N_2	M7		
2	IO_L30P_2	L7		
2	IO_L31N_2	J1	NC	
2	IO_L31P_2	H1	NC	
2	IO_L32N_2	L8	NC	
2	IO_L32P_2	M8	NC	
2	IO_L33N_2	K4	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
5	IO_L55N_5	AV28		
5	IO_L55P_5	AV27		
5	IO_L54N_5	AP27		
5	IO_L54P_5	AP26		
5	IO_L53N_5	AN25		
5	IO_L53P_5	AN26		
5	IO_L52N_5	AU29		
5	IO_L52P_5	AU28		
5	IO_L51N_5/VREF_5	AR28		
5	IO_L51P_5	AR27		
5	IO_L50N_5	AJ24		
5	IO_L50P_5	AJ25		
5	IO_L49N_5	AW30		
5	IO_L49P_5	AW29		
5	IO_L36N_5	AT29	NC	
5	IO_L36P_5	AT28	NC	
5	IO_L35N_5	AK25	NC	
5	IO_L35P_5	AL26	NC	
5	IO_L34N_5	AV31	NC	
5	IO_L34P_5	AV30	NC	
5	IO_L33N_5/VREF_5	AP29	NC	
5	IO_L33P_5	AP28	NC	
5	IO_L32N_5	AK26	NC	
5	IO_L32P_5	AJ26	NC	
5	IO_L31N_5	AW32	NC	
5	IO_L31P_5	AW31	NC	
5	IO_L30N_5	AM27		
5	IO_L30P_5	AM26		
5	IO_L29N_5	AN28		
5	IO_L29P_5	AN29		
5	IO_L28N_5	AU31		
5	IO_L28P_5	AU30		
5	IO_L27N_5/VREF_5	AT31		
5	IO_L27P_5	AT30		
5	IO_L26N_5	AH25		
5	IO_L26P_5	AH26		